



N- and P-Channel 20-V (D-S) MOSFET

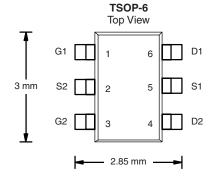
PRODUCT SUMMARY						
	V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)			
		0.080 at V _{GS} = 4.5 V	3.0			
N-Channel	20	0.100 at V _{GS} = 2.5 V	2.6			
		0.128 at V _{GS} = 1.8 V	2.3			
		0.145 at V _{GS} = - 4.5 V	- 2.2			
P-Channel	- 20	0.200 at V _{GS} = - 2.5 V	- 1.8			
		0.300 at V _{GS} = - 1.8 V	- 1.5			

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFETs: 1.8 V Rated
- Compliant to RoHS Directive 2002/95/EC

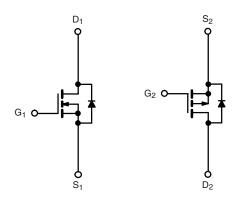


COMPLIANT
HALOGEN
FREE
Available



Ordering Information: Si3588DV-T1-E3 (Lead (Pb)-free)

Si3588DV-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted								
Parameter			N-Channel		P-Channel			
		Symbol	5 s	Steady State	5 s	Steady State	Unit	
Drain-Source Voltage		V_{DS}		20	- 20		V	
Gate-Source Voltage		V _{GS}	± 8					
Continuous Drain Current (T. 150°C)	T _A = 25 °C	- I _D	3.0	2.5	- 2.2	- 0.57		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		2.3	2.0	- 1.8	- 1.5		
Pulsed Drain Current		I _{DM}	± 8				Α	
Continuous Source Current (Diode Conduction) ^a		I _S	1.05	0.75	- 1.05	- 0.75		
W	T _A = 25 °C	P _D	1.15	0.83	1.15	0.083	W	
Maximum Power Dissipation ^a	T _A = 70 °C		0.73	0.53	0.73	0.53		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150				°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^a	t ≤ 5 s	R _{thJA}	93	110			
	Steady State	TithJA	130	150	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	90	90			

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static					,			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	N-Ch	0.45			.,	
		V _{DS} = V _{GS} , I _D = - 250 μA	P-Ch	- 0.45			V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	N-Ch			± 100	nA	
		V _{DS} = 0 V, V _{GS} = ± 8 V	P-Ch			± 100		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 16 V, V _{GS} = 0 V	N-Ch			1		
		V _{DS} = -16 V, V _{GS} = 0 V P-Ch V _{DS} = 16 V, V _{GS} = 0 V, T _J = 85 °C N-Ch				- 1	μΑ	
						10		
		V _{DS} = - 16 V, V _{GS} = 0 V, T _J = 85 °C	P-Ch			- 10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	N-Ch	5				
		$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	P-Ch	- 5			Α	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 3 \text{ A}$	N-Ch	N-Ch 0.064		0.080		
		V _{GS} = - 4.5 V, I _D = - 2.2 A	P-Ch		0.115	0.145		
		$V_{GS} = 2.5 \text{ V}, I_D = 2.6 \text{ A}$	N-Ch		0.080	0.100	Ω	
		V _{GS} = - 2.5 V, I _D = - 1.8 A	P-Ch		0.163	0.200		
		$V_{GS} = 1.8 \text{ V}, I_D = 2.3 \text{ A}$	N-Ch		0.104	0.128		
		V _{GS} = - 1.8 V, I _D = - 1.0 A	P-Ch		0.240	0.300		
	9 _{fs}	$V_{DS} = 5 \text{ V}, I_{D} = 3 \text{ A}$	N-Ch		9		s	
Forward Transconductance ^a		V _{DS} = - 5 V, I _D = - 2.2 A	P-Ch		5			
Diode Forward Voltage ^a	V _{SD}	I _S = 1.05 A, V _{GS} = 0 V	N-Ch		0.8	1.1	.,	
		I _S = - 1.05 A, V _{GS} = 0 V	P-Ch		- 0.8	- 1.1	V	
Dynamic ^b								
Total Gate Charge	Qg	N.O.	N-Ch		5	7.5	nC	
		N-Channel $V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 3 \text{ A}$	P-Ch		5	7.5		
Gate-Source Charge	Q_{gs}	V _{DS} = 10 v, v _{GS} = 4.0 v, 1 _D = 0 / 1	N-Ch		0.65			
		P-Channel	P-Ch		1.0			
Gate-Drain Charge	Q _{gd}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -2.2 \text{ A}$	N-Ch		0.9			
			P-Ch		0.9		<u> </u>	
Turn-On Delay Time Rise Time	t _{d(on)}	N-Channel	N-Ch		12	20	_	
		$V_{DD} = 10 \text{ V}, R_L = 10 \Omega$	P-Ch N-Ch		12 30	20 50		
		$I_D \cong 0.5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 6 \Omega$	P-Ch		29	50		
	t _{d(off)}	- P-Channel	N-Ch		28	50	1	
		P-Channel $V_{DD} = -4 \text{ V}, R_L = 8 \Omega$	P-Ch		24	45	ns	
Turn-Off Delay Time		_				20	1	
·		$I_D \cong -1 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_a = 6 \Omega$	N-Ch		12	20		
Turn-Off Delay Time Fall Time	t _f	$I_D \cong$ - 1 A, V_{GEN} = - 4.5 V, R_g = 6 Ω	N-Ch P-Ch		30	50 50		
·	t _f	$I_D \cong -1 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 6 \Omega$ $I_F = 1.05 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$						

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

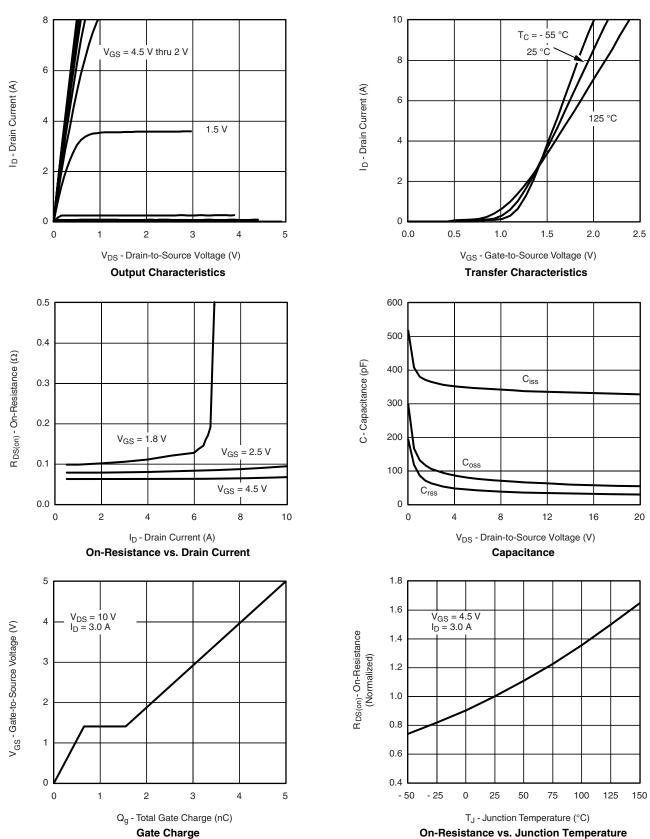
a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$

b. Guaranteed by design, not subject to production testing.



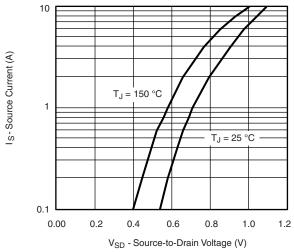


N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

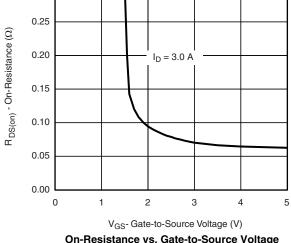


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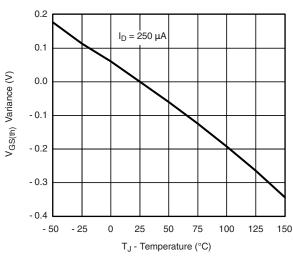


Source-Drain Diode Forward Voltage

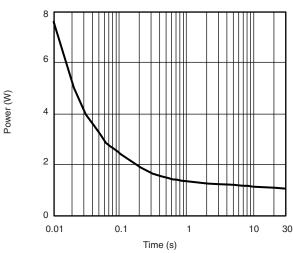


0.30

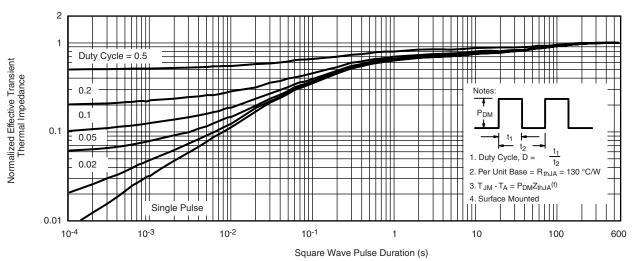
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient

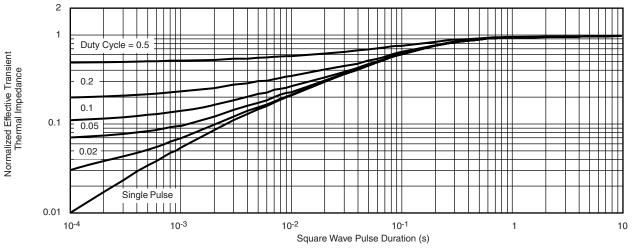


Normalized Thermal Transient Impedance, Junction-to-Ambient



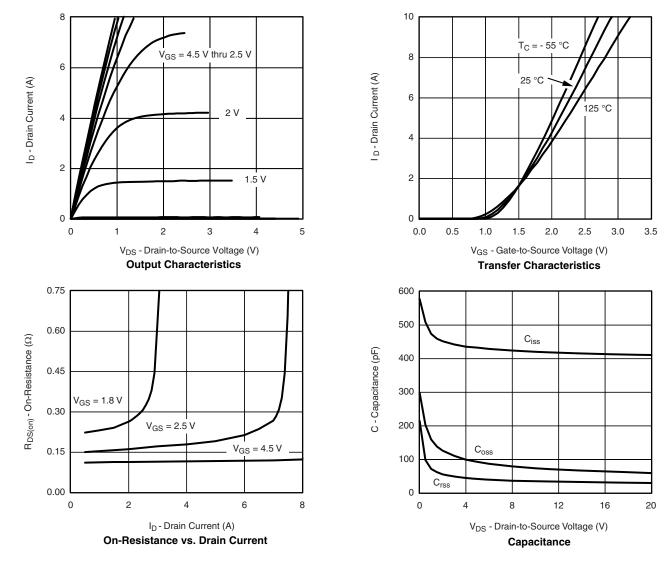


N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

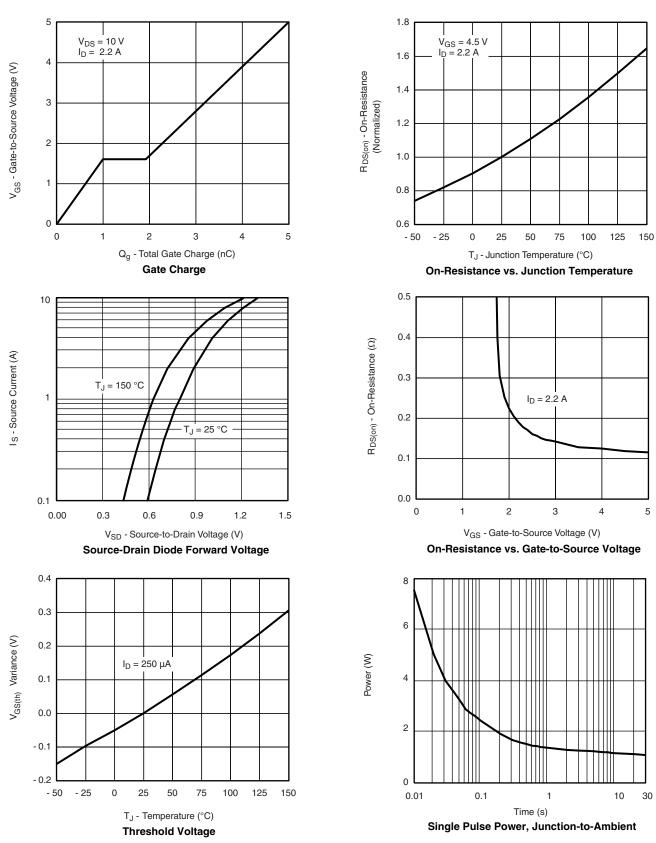
P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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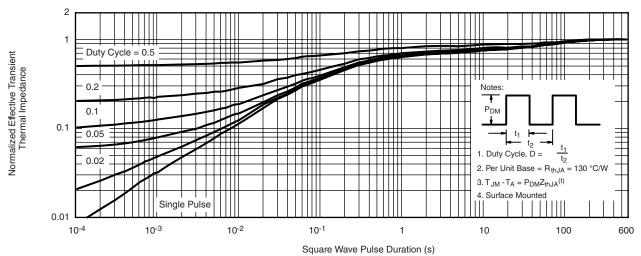


P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

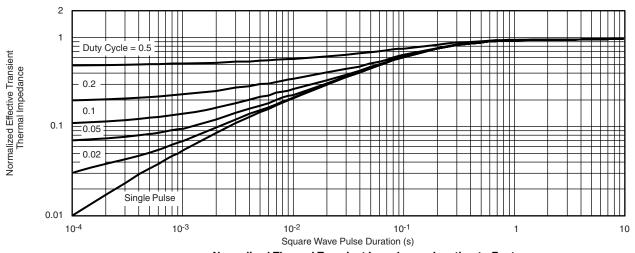




P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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